

STK802 N-channel 30V - 0.0019Ω - 34A - PolarPAK[®] STripFET[™] Power MOSFET

PRELIMINARY DATA

General features

Туре	V _{DSS}	R _{DS(on)}	R _{DS(on)} *Q _g	P _{TOT}
STK802	30V	<0.0025Ω	105.6nC*mΩ	5.2W

- Ultra low top and bottom junction to case thermal resistance
- Very low on resistance
- 100% Rg tested
- Fully incapsulated die
- In compliance with the 2002/95/EC european directive
- PolarPAK[®] is a registered trademark of VISHAY

Description

This Power MOSFET is the latest development of STMicroelectronics unique "single feature size™" strip-based process. The resulting transistor shows extremely high packing density for low onresistance, moreover the double sides cooling package with ultra low junction to case thermal resistance allows to handle higher levels of current.

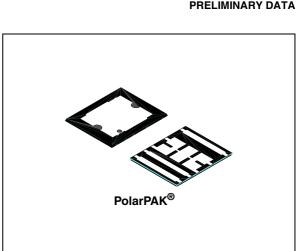
Applications

Switching application

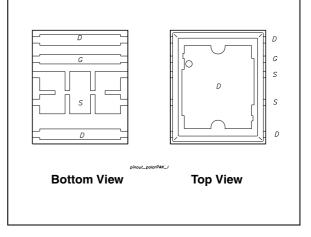
Order codes

Part number	Marking	Package	Packaging	
STK802	K802	PolarPAK [®]	Tape & reel	





Internal schematic diagram



1/9

1 Electrical ratings

Table 1.	Absolute	maximum	ratings
	Abounde	IIIuAIIIIuIII	ruungo

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	30	V
V _{GS} ⁽¹⁾	Gate-source voltage	± 16	V
V _{GS} ⁽²⁾	Gate-source voltage	± 18	V
I _D ⁽⁴⁾	Drain current (continuous) at $T_{C} = 25^{\circ}C$	34	А
۱ _D	Drain current (continuous) at $T_{C} = 100^{\circ}C$	21	А
I _{DM} ⁽³⁾	Drain current (pulsed)	136	А
P _{TOT} ⁽⁴⁾	Total dissipation at $T_{C} = 25^{\circ}C$	5.2	W
	Derating factor	0.0416	W/°C
T _j T _{stg}	Operating junction temperature Storage temperature	-55 to 150	°C

1. Continuous mode

2. Guaranteed for test time \leq 15ms

3. Pulse width limited by package

4. When mounted on FR-4 board of 1inch² , 2 oz Cu and \leq 10sec

Symbol	Symbol Parameter		Max.	Unit
Rthj-amb ⁽¹⁾	Thermal resistance junction-amb	20	24	°C/W
Rthj-c ⁽²⁾	Thermal resistance junction-case (Top Drain)	0.8	1	°C/W
Rthj-c ⁽³⁾	Thermal resistance junction-case (Source)	2.2	2.7	°C/W

1. When mounted on FR-4 board of 1inch² , 2 oz Cu and \leq 10sec

2. Steady state

3. Measured at Source pin when the device is mounted on FR-4 board in steady state

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 5.						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 250μA, V _{GS} = 0	30			v
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = Max rating, V _{DS} = Max rating,Tc=125°C			1 10	μΑ μΑ
I _{GSS}	Gate body leakage current (V _{DS} = 0)	$V_{GS} = \pm 16V$			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1		2.5	V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10V, I _D = 17A V _{GS} = 4.5V, I _D = 17A		0.0019 0.0024	0.0025 0.0031	Ω Ω

Table 3. On/off

Table 4. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} =25V, f=1 MHz, V _{GS} =0		5940 890 67		pF pF pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V_{DD} =15V, I_D = 34A V_{GS} =4.5V (see Figure 2)		44 Tbd Tbd		nC nC nC



	•					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r	Turn-on delay time Rise time	$V_{DD}=15V, I_{D}=17A,$ $R_{G}=4.7\Omega, V_{GS}=4.5V$ (see Figure 1)		Tbd Tbd		ns ns
t _{d(off)} t _f	Turn-off delay time Fall time	V_{DD} =15V, I _D = 17A, R _G =4.7 Ω , V _{GS} =4.5V (see Figure 1)		Tbd Tbd		ns ns

Table 5.Switching times

 Table 6.
 Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD} I _{SDM} ⁽¹⁾	Source-drain current Source-drain current (pulsed)				34 136	A A
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 17A, V _{GS} =0			1.2	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I _{SD} = 34A, di/dt = 100A/µs, V _{DD} =20V, Tj=150°C (<i>see Figure 6)</i>		Tbd Tbd Tbd		ns nC A

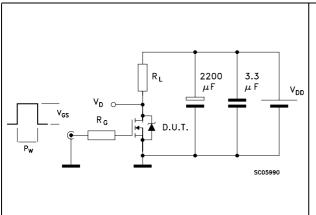
1. Pulse width limited by package

2. Pulsed: pulse duration = $300\mu s$, duty cycle 1.5%



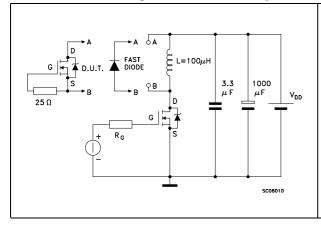
3 Test circuits

Figure 1. Switching times test circuit for resistive load



127 47K Ω 1KΩ 100nF I_G=CONST 100 Ω $V_i = 20V = V_{GMAX}$ 🖈 D.U.T. ()2200 2.7ΚΩ ۷ $\doteq \mu$ ø 47K Ω 1KΩ P., SC06000

Figure 3. Test circuit for inductive load switching and diode recovery times





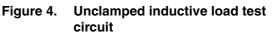
V_D -

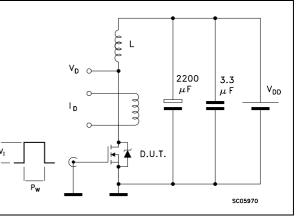
I DM

۱_D

V_{DD}

 $V_{(BR)DSS}$





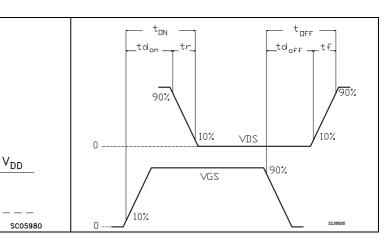


Figure 6. Switching time waveform

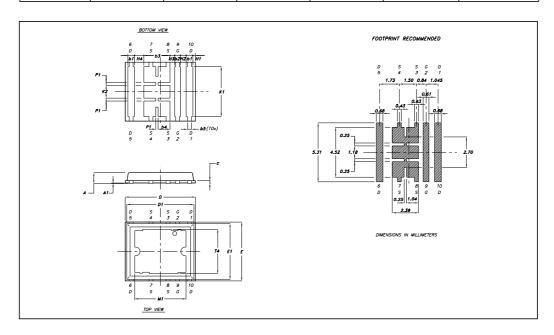


4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com



	Polar	PAK [®] (Opt	tion "L") ME	ECHANICAL	DATA		
REF.		mm		inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	0.75	0.80	0.85	0.030	0.031	0.033	
A1			0.05			0.002	
b1	0.48	0.58	0.68	0.019	0.023	0.027	
b2	0.41	0.51	0.61	0.016	0.020	0.024	
b3	2.19	2.29	2.39	0.086	0.090	0.094	
b4	0.89	1.04	1.19	0.035	0.041	0.047	
b5	0.23	0.33	0.43	0.009	0.013	0.017	
С	0.20	0.25	0.30	0.008	0.010	0.012	
D	6	6.15	6.30	0.236	0.242	0.248	
D1	5.74	5.89	6.04	0.226	0.232	0.238	
E	5.01	5.16	5.31	0.197	0.203	0.209	
E1	4.75	4.90	5.05	0.187	0.193	0.199	
H1	0.23			0.009			
H2	0.45		0.56	0.020		0.022	
H3	0.31	0.41	0.51	0.012	0.016	0.020	
H4	0.45	-	0.56	0.020		0.022	
K1	4.22	4.37	4.52	0.166	0.172	0.178	
K2	1.08	1.13	1.18	0.043	0.044	0.046	
K3	1.37	-		0.054			
K4	0.24			0.009			
M1	4.30	4.50	4.70	0.169	0.177	0.185	
M2	3.43	3.58	3.73	0.135	0.141	0.147	
M3	0.22			0.009			
M4	0.05			0.002			
P1	0.15	0.20	0.25	0.006	0.008	0.010	
T1	3.48	3.64	4.10	0.137	0.143	0.150	
T2	0.56	0.76	0.95	0.22	0.030	0.037	
Т3	1.20			0.051			
T4	3.90			0.154			
T5		0.18	0.36		0.007	0.014	
<	0°	10°	12°	0°	10°	12°	



57

5 Revision history

Date	Revision	Changes
10-Oct-2006	1	First version
19-Dec-2006	2	Small text changes, update test conditions (<i>Table 1., Table 3., Table 4., Table 5., Table 6.</i>)



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2006 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

